

Thermal-Mechanical Specifications

Parameters	Symbol	Test Conditions	Max	Unit
Junction Temperature	T_J		-55 to +150	°C
Storage Temperature	T_{stg}		-55 to +150	°C
Maximum Thermal Resistance Junction to Ambient	R_{thJA}	DC operation	75	°C/W
Maximum Thermal Resistance Junction to Lead	R_{thJL}^*		3.5	°C/W
Approximate Weight	wt		0.08	g
Case Style	TO-277B			

*Lead temperature monitored at the cathode pin

Figure 1: Forward Current Derating Curve

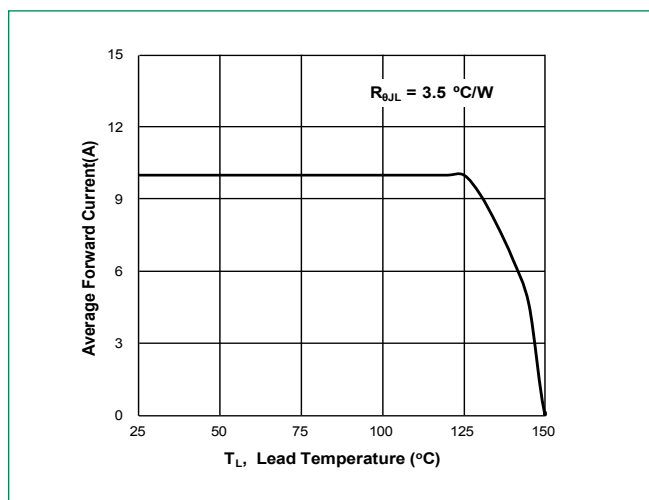


Figure 2: Forward Power Loss Characteristics

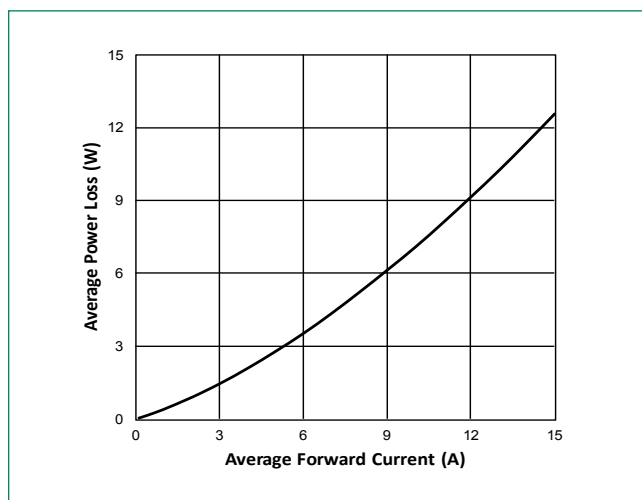


Figure 3: Typical Forward Characteristics

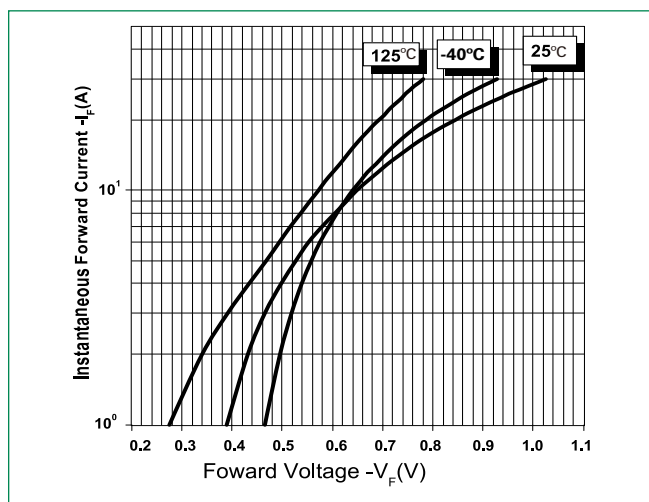


Figure 4: Typical Reverse Characteristics

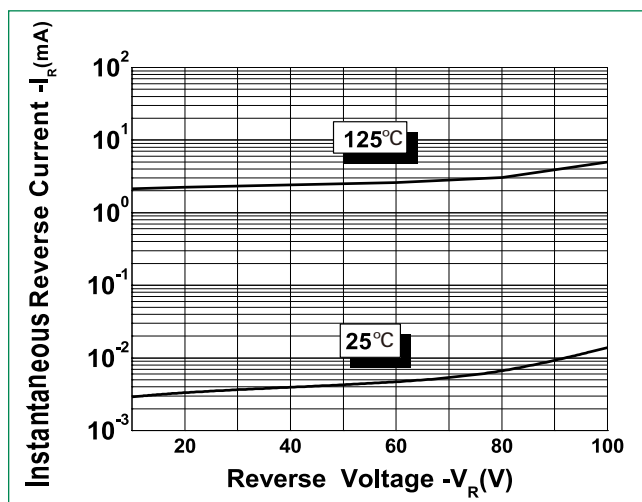
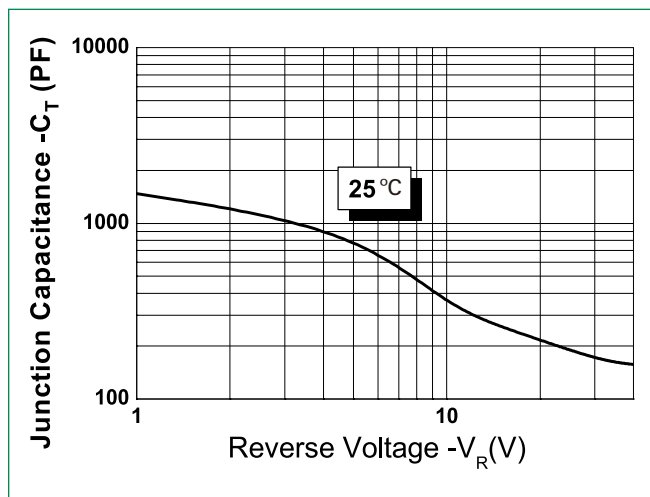
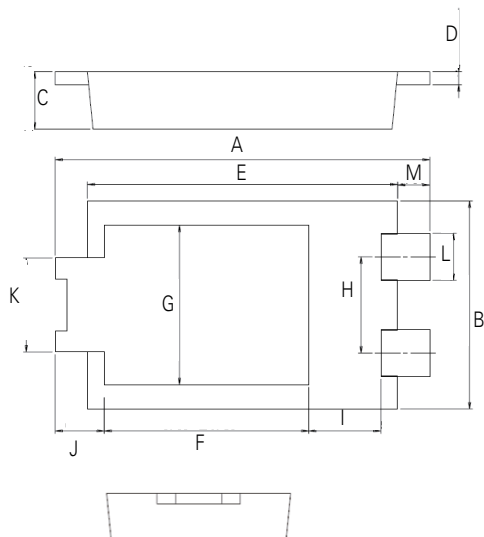


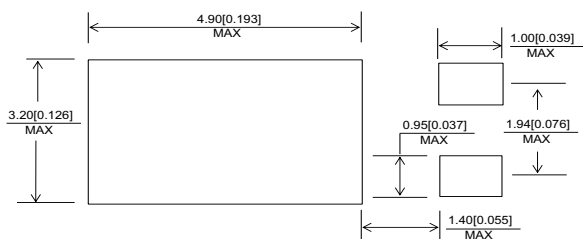
Figure 5: Typical Junction Capacitance



Dimensions-TO-277B

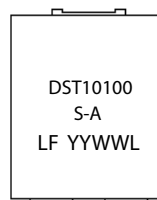


Mounting Pad Layout



Symbol	Millimeters		
	Min	Typ	Max
A	6.30	6.50	6.70
B	3.88	3.98	4.08
C	0.95	1.10	1.25
D	0.20	0.25	0.30
E	5.28	5.38	5.48
F	3.40	3.55	3.70
G	2.90	3.05	3.20
H	1.74	1.84	1.94
I	1.10	1.25	1.40
J	-	0.85	-
K	1.70	1.80	1.90
L	0.85	0.90	0.95
M	-	0.56	-

Part Numbering and Marking System

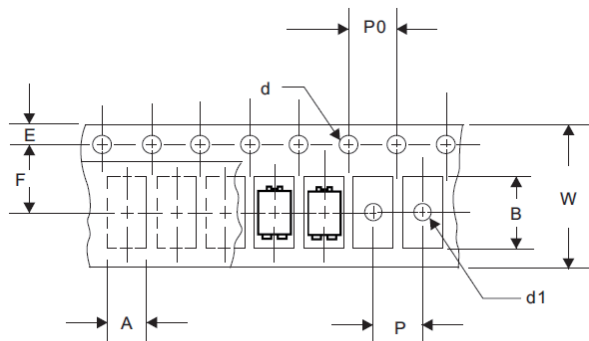


DST = Device Type
 10 = Forward Current (10A)
 100 = Reverse Voltage (100V)
 S = Package Type
 A = AEC-Q101 qualified device
 LF = Littelfuse
 YY = Year
 WW = Week
 L = Lot Number

Packing Options

Part Number	Marking	Packing Mode	M.O.Q
DST10100S-A	DST10100S-A	5000pcs / Reel	5000

Carrier Tape & Reel Specification



Symbol	Millimeters	
	Min	Max
A	4.28	4.48
B	6.80	7.00
d	1.40	1.60
d1	-	1.50
E	1.65	1.85
F	7.40	7.60
P	5.40	5.60
P0	3.90	4.10
W	11.70	12.30